

# PMEG045V100EPD

45 V, 10 A low VF MEGA Schottky barrier rectifier

4 December 2014

**Product data sheet** 

# 1. General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a CFP15 (SOT1289) power and flat lead Surface-Mounted Device (SMD) plastic package.

#### 2. Features and benefits

- Average forward current: I<sub>F(AV)</sub> ≤ 10 A
- Reverse voltage: V<sub>R</sub> ≤ 45 V
- Extremely low forward voltage
- · High power capability due to clip-bonding technology and heat sink
- Small and thin SMD power plastic package, typical height 0.78 mm
- AEC-Q101 qualified

# 3. Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- Freewheeling application
- Reverse polarity protection
- Low power consumption application

### 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; $T_{sp} \le$ 160 °C; square wave	-	-	10	A
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C	-	-	45	V
V <sub>F</sub>	forward voltage	$I_F$ = 10 A; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_j$ = 25 °C; pulsed	-	420	490	mV
I <sub>R</sub>	reverse current	$V_R = 10 \text{ V}; t_p \le 3 \text{ ms}; \delta \le 0.3;$ $T_j = 25 \text{ °C}; \text{ pulsed}$	-	20	50	μΑ
		$V_R = 45 \text{ V}; t_p \le 3 \text{ ms}; \delta \le 0.3;$ $T_j = 25 \text{ °C}; \text{ pulsed}$	-	250	600	μΑ



# 5. Pinning information

#### Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	Α	anode		K PA
2	Α	anode	3	aaa-009063
3	К	cathode	2 CFP15 (SOT1289)	

# 6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PMEG045V100EPD	CFP15	plastic, thermal enhanced ultra thin SMD package; 3 leads; body: 5.8 x 4.3 x 0.78 mm	SOT1289

# 7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG045V100EPD	045V 100E

# 8. Limiting values

## Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	45	V
I <sub>F</sub>	forward current	T <sub>sp</sub> = 155 °C; δ = 1		-	14	Α
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; $T_{sp} \le$ 160 °C; square wave		-	10	A
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 8 ms; $T_{j(init)}$ = 25 °C; square wave		-	210	A
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1]	-	1.66	W
			[2]	-	2.15	W
			[3]	-	3.75	W
Tj	junction temperature			-	175	°C
T <sub>amb</sub>	ambient temperature			-55	175	°C

PMEG045V100EPD

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Symbol	Parameter	Conditions	Min	Max	Unit
T <sub>stg</sub>	storage temperature		-65	175	°C

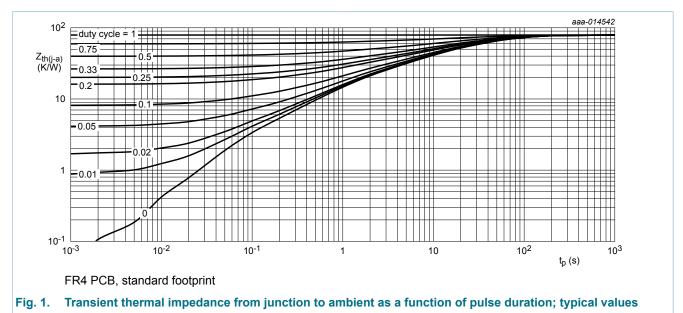
- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [3] Device mounted on a ceramic Printed-Circuit Board (PCB), Al<sub>2</sub>O<sub>3</sub>, standard footprint.

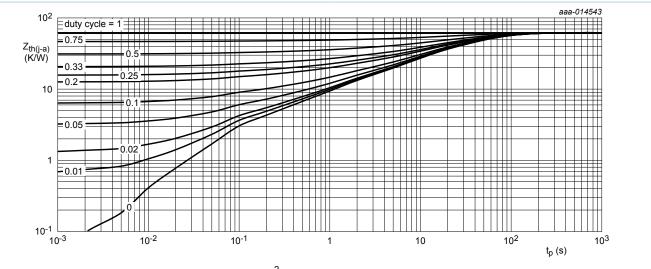
### 9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub> thermal resistance from junction to ambient		in free air	[1][2]	-	-	90	K/W
		[1][3]	-	-	70	K/W	
	ambient		[1][4]	-	-	40	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		[5]	-	-	3	K/W

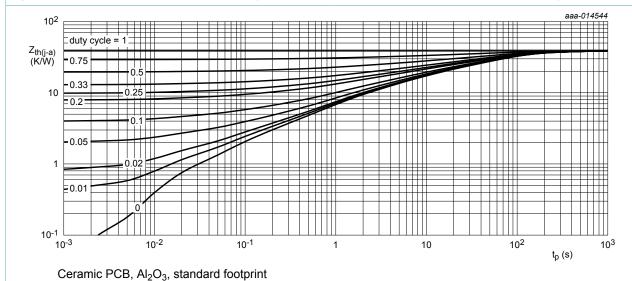
- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P<sub>R</sub> are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [4] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.
- [5] Soldering point of cathode tab.





FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

Transient thermal impedance from junction to ambient as a function of pulse duration; typical values Fig. 2.



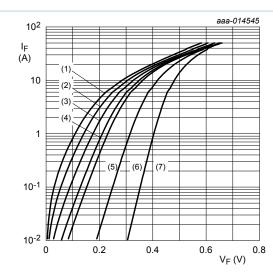
Transient thermal impedance from junction to ambient as a function of pulse duration; typical values Fig. 3.

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# 10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	$I_R$ = 5 mA; $T_j$ = 25 °C; $t_p \le$ 1.2 ms; $\delta \le$ 0.12; pulsed	45	-	-	V
$V_{F}$	forward voltage	$I_F$ = 1 A; $t_p \le 300$ μs; $δ \le 0.02$ ; $T_j$ = 25 °C; pulsed	-	320	360	mV
		$I_F$ = 2 A; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_j$ = 25 °C; pulsed	-	340	-	mV
		$I_F$ = 5 A; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_j$ = 25 °C; pulsed	-	380	430	mV
		$I_F$ = 10 A; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_j$ = 25 °C; pulsed	-	420	490	mV
		$I_F$ = 10 A; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_j$ = 125 °C; pulsed	-	330	-	mV
I <sub>R</sub> reverse current	reverse current	$V_R$ = 5 V; $t_p \le 3$ ms; $\delta \le 0.3$ ; $T_j$ = 25 °C; pulsed	-	15	-	μA
		$V_R$ = 10 V; $t_p \le 3$ ms; $\delta \le 0.3$ ; $T_j$ = 25 °C; pulsed	-	20	50	μA
		$V_R$ = 30 V; $t_p \le$ 3 ms; $\overline{o} \le$ 0.3; $T_j$ = 25 °C; pulsed	-	60	-	μA
		$V_R = 45 \text{ V}; t_p \le 3 \text{ ms}; \delta \le 0.3;$ $T_j = 25 ^{\circ}\text{C}; \text{ pulsed}$	-	250	600	μA
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	1190	-	pF
		V <sub>R</sub> = 10 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	400	-	pF
t <sub>rr</sub>	reverse recovery time step recovery	$I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 \text{ °C}$	-	37	-	ns
t <sub>rr</sub>	reverse recovery time ramp recovery	$dI_F/dt = 200 \text{ A/}\mu\text{s}; T_j = 25 \text{ °C}; I_F = 6 \text{ A};$ $V_R = 26 \text{ V}$	-	17	-	ns
$V_{FRM}$	peak forward recovery voltage	$I_F = 0.5 \text{ A}$ ; $dI_F/dt = 20 \text{ A/µs}$ ; $T_j = 25 \text{ °C}$	-	308	-	mV



pulsed condition

(1)  $T_i = 175 \, ^{\circ}C$ 

(2)  $T_i = 150 \, ^{\circ}C$ 

(3)  $T_j = 125 \, ^{\circ}\text{C}$ 

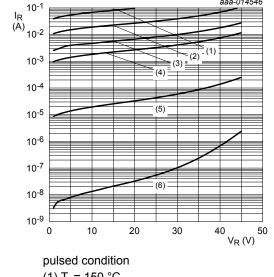
(4)  $T_i = 100 \, ^{\circ}C$ 

 $(5) T_i = 85 °C$ 

(6)  $T_i = 25 \,^{\circ}C$ 

 $(7) T_i = -40 °C$ 

Forward current as a function of forward Fig. 4. voltage; typical values



(1)  $T_i = 150 \, ^{\circ}C$ 

(2)  $T_i = 125 \, ^{\circ}C$ 

(3)  $T_i = 100 \, ^{\circ}C$ 

(4)  $T_i = 85 \, ^{\circ}C$ 

(5)  $T_i = 25 \,^{\circ}C$ 

(6)  $T_i = -40 \, ^{\circ}C$ 

Fig. 5. Reverse current as a function of reverse voltage; typical values

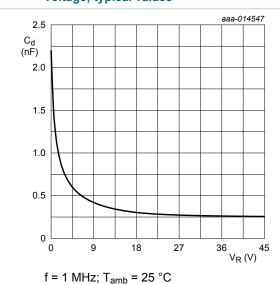
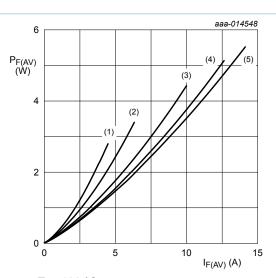


Fig. 6. Diode capacitance as a function of reverse voltage; typical values



T<sub>i</sub> = 100 °C

 $(1) \delta = 0.1$ 

 $(2) \delta = 0.2$ 

 $(3) \delta = 0.5$ 

 $(4) \delta = 0.8$ 

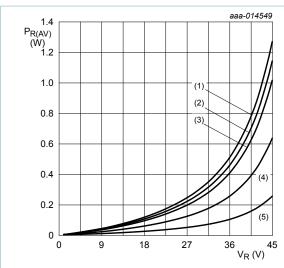
 $(5) \delta = 1$ 

Fig. 7. Average forward power dissipation as a function of average forward current; typical values

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T<sub>i</sub> = 100 °C

, (1) δ = 1

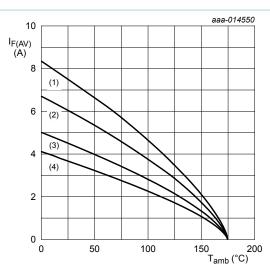
 $(2) \delta = 0.9$ 

 $(3) \delta = 0.8$ 

(4)  $\delta = 0.5$ 

 $(5) \delta = 0.2$ 

Fig. 8. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

T<sub>i</sub> = 175 °C

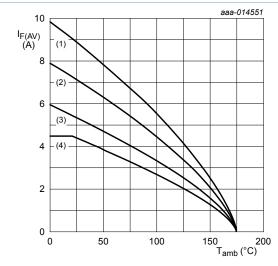
(1)  $\delta$  = 1; DC

(2)  $\delta$  = 0.5; f = 20 kHz

(3)  $\delta$  = 0.2; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

T<sub>i</sub> = 175 °C

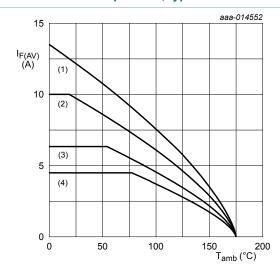
(1)  $\delta$  = 1; DC

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 10. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint

T<sub>i</sub> = 175 °C

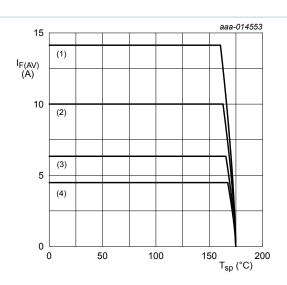
(1)  $\delta$  = 1; DC

(2)  $\delta$  = 0.5; f = 20 kHz

(3)  $\delta$  = 0.2; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 11. Average forward current as a function of ambient temperature; typical values



 $T_j = 175$  °C

(1)  $\delta$  = 1; DC

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta$  = 0.2; f = 20 kHz

(4)  $\delta$  = 0.1; f = 20 kHz

Fig. 12. Average forward current as a function of solder point temperature; typical values

# 11. Test information

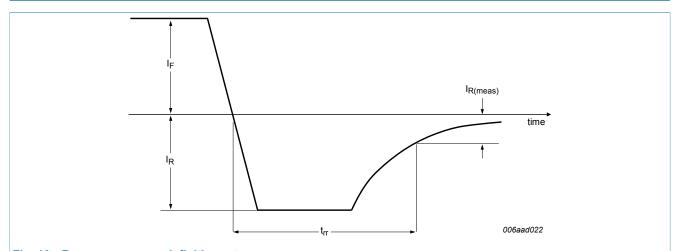


Fig. 13. Reverse recovery definition; step recovery

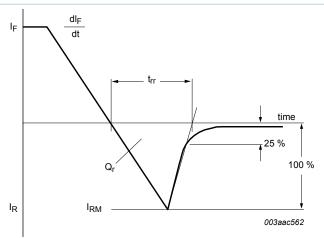


Fig. 14. Reverse recovery definition; ramp recovery

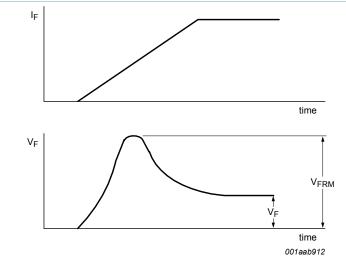
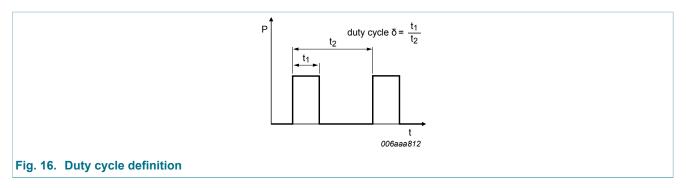


Fig. 15. Forward recovery definition

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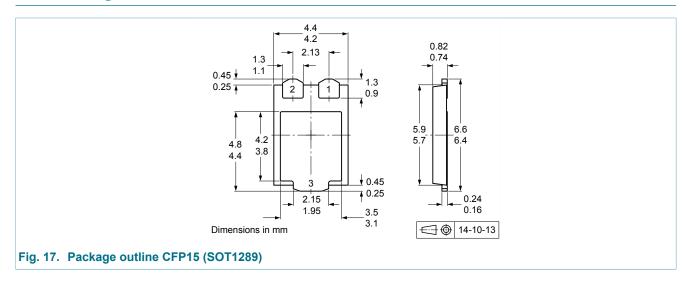


The current ratings for the typical waveforms are calculated according to the equations:  $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current,  $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_M \times \sqrt{\delta}$  with  $I_{RMS}$  defined as RMS current.

## 11.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

# 12. Package outline



# 13. Soldering

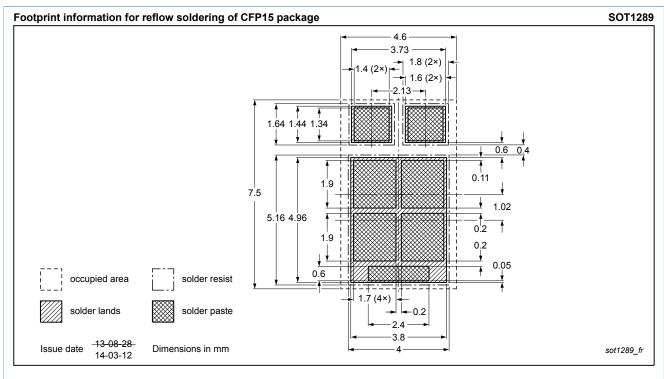


Fig. 18. Reflow soldering footprint for CFP15 (SOT1289)

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# 14. Revision history

#### Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG045V100EPD v.2	20141204	Product data sheet	-	PMEG045V100EPD v.1
Modifications:	Product status	changed		
PMEG045V100EPD v.1	20140704	Preliminary data sheet	-	-

# 15. Legal information

#### 15.1 Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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